

# TLE5046SiC-PWM2

## High-End GMR Wheel Speed Sensor ASIL B(D)

### Features and Benefits

- Developed according to ISO 26262, compliant to the requirements of ASILB(D)
- Low jitter 0.02% due to high switching accuracy enables iTPMS
- Wide operating junction temperature range -40°C to 190°C
- Two-wire current interface providing speed and direction information
- High sensitivity enables outstanding air gap performance along with immunity against y-displacement effect
- Robustness against external magnetic disturbances up to 2 mT through differential sensing principle
- Advanced stop-start capabilities enabled by
  - Innovative watchdog concept to guarantee maximum signal availability
  - No loss of direction information during start stop condition
- Small sensor package 5 x 3 mm without need of external capacitor saves module size, increases robustness against mechanical stress and enables design freedom
- Advanced EMC concept maximizes the availability of the sensor signal
- New established Micro Break feature designed to be immune against disturbances on supply line



### PRO-SIL™ for ISO26262

TLE5046SiC is accompanied by accurate safety analysis and complete documentation to enable the system integrator to quickly evaluate the compatibility with the system/item and start the integration process. The provided Safety Manual explains how to use the sensor in safety critical applications and the Safety Analysis Summary Report provides the key results of the safety analysis.

<https://www.infineon.com/cms/en/applications/automotive/chassis-safety-and-adas/?redirId=64493>

### Description

The TLE5046SiC-PWM2 is a wheel speed sensor with direction indication designed for sophisticated vehicle control systems. TLE5046SiC-PWM2 shows best in class jitter performance making it the best choice for wheel speed applications. The rotational speed is sensed with high accuracy, enabling the sensor to be used as a component of indirect tire pressure monitoring systems (iTPMS). It is based on integrated giant magneto resistance (iGMR). Excellent sensitivity to magnetic field is specified over a wide temperature range. To meet harsh automotive requirements, robustness to electrostatic discharge (ESD) and electromagnetic compatibility (EMC) has been maximized without the need of additional external components.

### Product Variants and Ordering Codes

TLE5046SiC is ASIL B(D) compliant and can be integrated in an ASIL D system. It has a very low FIT rate, due to the design and technical concept.

The safety concept is described in detail in the Safety Analysis Summary Report [10] and the Safety Manual [11] and will be delivered on request.

# TLE5046SiC-PWM2

## High-End GMR Wheel Speed Sensor ASIL B(D)



### Product Variants and Ordering Codes

**Table 1**                      **Product Variants**

Product Type	Load Resistor <sup>1)</sup>	Marking	Ordering Code	Package	ASIL
TLE5046SiC-PWM2-R100 <sup>1) 2)</sup>	$50\ \Omega \leq R_M \leq 100\ \Omega$	462X0I	SP005965719	PG-SSO-2-1	ASIL B(D)
TLE5046SiC-PWM2-R050 <sup>1) 2)</sup>	$15\ \Omega \leq R_M \leq 50\ \Omega$	462X0E	SP005965728	PG-SSO-2-1	ASIL B(D)

1) see [Chapter 1](#)

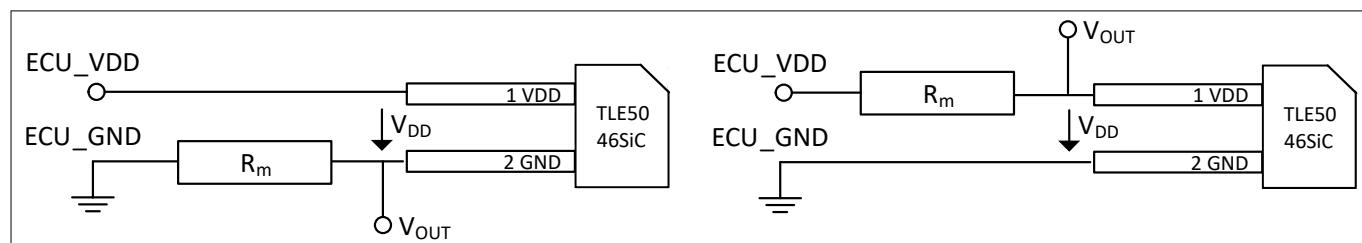
2) enhanced Safety Concept, for details see Safety Manual

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## 1 Application Circuit

### 1 Application Circuit



**Figure 1** Pin Configuration PG-SSO-2-1

**Table 2** Pin Description

Pin No.	Symbol	Function
1	$V_{DD}$	Supply voltage
2	GND	Ground

## 2 Absolute Maximum Ratings

## 2 Absolute Maximum Ratings

**Table 3** Maximum Ratings<sup>1)</sup>

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Supply voltage	$V_{DD}$	-	-	24	V	max. 30 min @ $T_J = 25 \pm 5^\circ\text{C}$
		-0.6	-	-	V	$T_J < 80^\circ\text{C}$ , $I_{DD}$ reverse current limit applies
Reverse current	$I_{DD}$	-200	-	-	mA	$t = \text{max. } 4 \text{ h}$
Junction temperature <sup>2)</sup>	$T_J$	-40	-	190	$^\circ\text{C}$	max. 4 h, $V_{DD} < 16.5 \text{ V}$
Magnetic flux density	$B_{\text{max}_x}$	-	-	250	mT	max. 1 min @ $T_A \leq 85^\circ\text{C}$
	$B_{\text{max}_y}$	-	-	-	-	-
	$B_{\text{max}_z}$	-	-	500	mT	max. 1 min @ $T_A \leq 85^\circ\text{C}$

- 1) Stresses above listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.
- 2) This life time statement is an anticipation based on extrapolation of Infineon qualification test results. The actual life time of a component depends on its form of application and type of use etc. and may deviate from such a statement. The life time statement shall in no event extend the agreed warranty period.

**Table 4** Lifetime Conditions<sup>1)</sup>

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Passive overall lifetime	$L_{T\text{passive}}$	15	-	-	years	$T_J \leq 50^\circ\text{C}$ , $V_{DD} = 0 \text{ V}$ non active operating condition
Active lifetime	$t_L$	42500	-	-	hours	incl. 30000 h battery charging time
Power-on cycles	$n_{PO}$	$10^6$	-	-	-	$V_{DD} = 12 \text{ V} \rightarrow 0 \text{ V} \rightarrow 12 \text{ V}$ ; $T_A = 25^\circ\text{C}$

- 1) This life time statement is an anticipation based on extrapolation of Infineon qualification test results. The actual life time of a component depends on its form of application and type of use etc. and may deviate from such a statement. The life time statement shall in no event extend the agreed warranty period.

### 3 Operating Range

## 3 Operating Range

The following operating conditions must not be exceeded in order to ensure correct operation.

**Table 5**      **Operating Range**

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Supply voltage	$V_{DD}$	5.2	-	20	V	TLE5046SiC-R100
		4.25	-	20	V	TLE5046SiC-R050
Load resistor	$R_m$	50		100	$\Omega$	-R100 <a href="#">Chapter 5.2.2</a>
		15		50	$\Omega$	-R050 <a href="#">Chapter 5.2.2</a>
Junction temperature mission profile <sup>1)</sup>	$T_J$	-40		125	$^{\circ}\text{C}$	either 10000 h
		-40		150	$^{\circ}\text{C}$	or, 5000 h
		-40		160	$^{\circ}\text{C}$	or, 2500 h
		-40		170	$^{\circ}\text{C}$	or, 500 h
		-40		110	$^{\circ}\text{C}$	or, 12500 h
		-40		190	$^{\circ}\text{C}$	additional 4 h, $V_{DD} < 16.5 \text{ V}$
		-10		60	$^{\circ}\text{C}$	additional 30000 h (battery charging time)
Supply voltage modulation <sup>2)</sup>	$V_{AC}$			6	Vpp	$V_{DD} = 13.5 \text{ V}$ , $10 < f_{mod} < 150 \text{ kHz}$ , sinusoidal shape of supply voltage modulation
Magnetic signal frequency <sup>2)</sup>	$f_{mag}$	0	-	3000	Hz	
Minimum differential magnetic input signal amplitude, magnetic encoder application <sup>3)</sup>	$dB_{limit\_x}$ $T_a = 25^{\circ}\text{C}$	70	90	110	$\mu\text{T}$	99% criterion, <a href="#">Figure 15</a>
Minimum differential magnetic input signal amplitude, magnetic encoder application <sup>2) 3)</sup>	$dB_{limit\_x}$ $T_a = -40^{\circ}\text{C}$	80	100	120	$\mu\text{T}$	99% criterion
Minimum differential magnetic input signal amplitude, magnetic encoder application <sup>2) 3)</sup>	$dB_{limit\_x}$ $T_a = 175^{\circ}\text{C}$	30	50	70	$\mu\text{T}$	99% criterion
Magnetic induction amplitude at each GMR sensing element <sup>2)</sup>	$B_x$	-25	-	25	mT	$T_J = 25^{\circ}\text{C}$ ; the $-0.2\%/^{\circ}\text{K}$ TC of pole wheel must be taken into account
Dynamic and static homogeneous external disturbance fields <sup>2)</sup>	$B_{ext\_XYZ}$	-2		2	mT	In calibrated mode. Same field at both probes, no unwanted pulses
Differential input signal amplitude after nonrecurring air-gap change	$k_{jump}$	60	-	200	%	Within $\geq 3$ signal periods. No pulse failure, period jitter and duty cycle exceeding specification; see <a href="#">Figure 3</a>

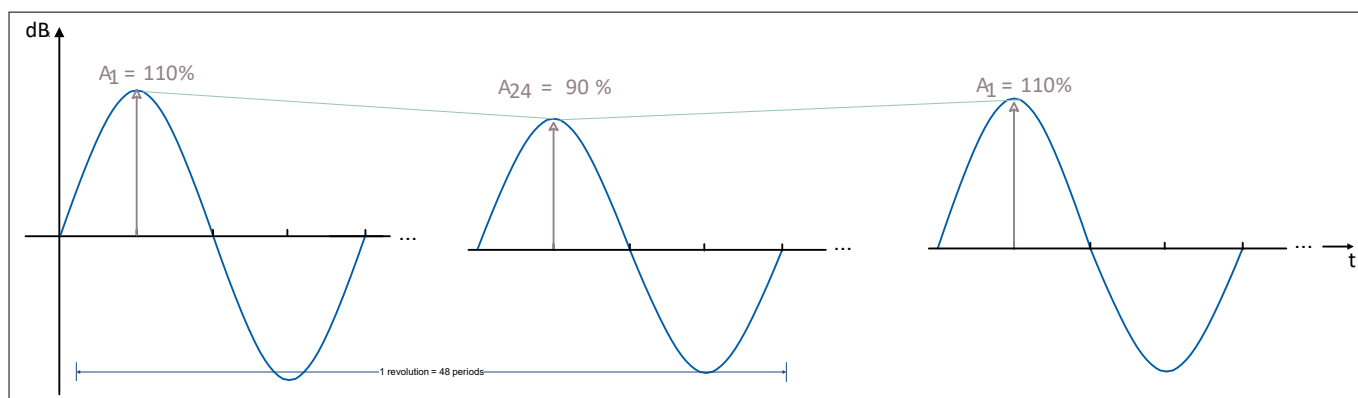
**(table continues...)**

### 3 Operating Range

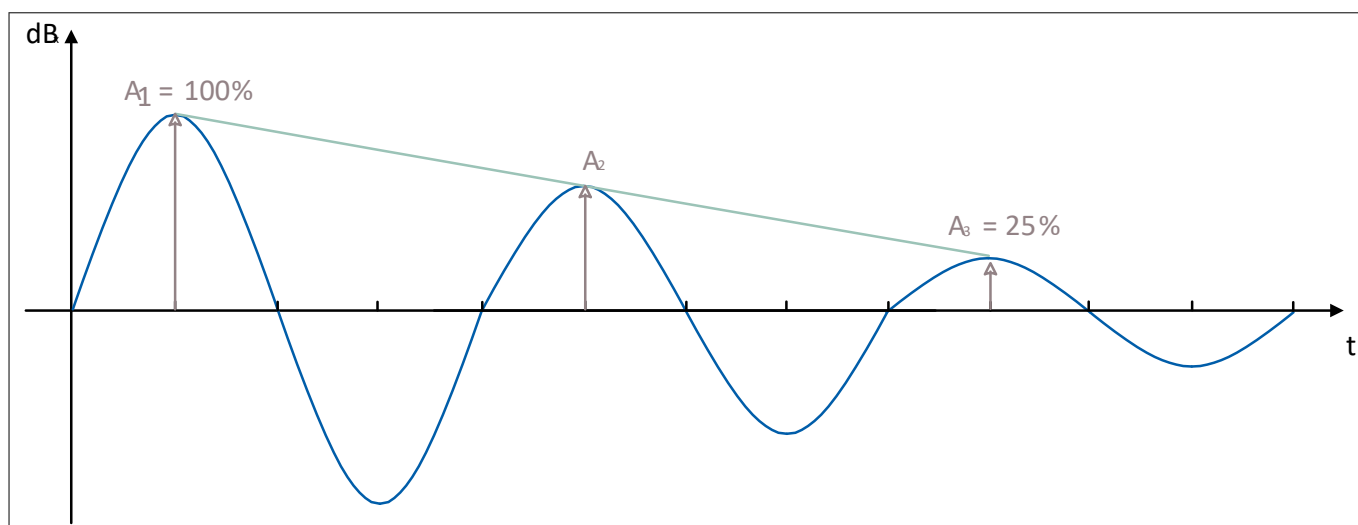
**Table 5** (continued) Operating Range

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Differential input signal amplitude change because of a recurring air-gap variation	$k_{\text{runout}}$	90	-	110	%	Once per revolution with 48 periods; see <a href="#">Figure 2</a>
Typical thermal resistance of sensor module <sup>4)</sup>	$R_{\text{thJA}}$		120		K/W	Including customer overmolding

- 1) This life time statement is an anticipation based on extrapolation of Infineon qualification test results. The actual life time of a component depends on its form of application and type of use etc. and may deviate from such a statement. The life time statement shall in no event extend the agreed warranty period.
- 2) Not subject to production test, verified by design/characterization.
- 3) 99% criterion is defined as 1% of the magnetic edges are not represented as signal edges at the electric interface. Test condition: 1 missing pulse out of 100, valid for  $f_{\text{mag}} \leq 10$  Hz; 10 missing pulses out of 1000, valid for  $f_{\text{mag}} > 10$  Hz. An implemented temperature coefficient compensates the magnetic material temperature dependency (-0.2% per Kelvin) and keeps the air gap over temperature constant.
- 4) Calculation ambient temperature  $T_A \rightarrow$  junction temperature  $T_J$ :  $T_J = T_A + \Delta T_{\text{JA}}$   
 $\Delta T_{\text{JA\_typ}}$  (typical value) =  $13.5 \text{ V} * 10.5 \text{ mA} * 120 \text{ K/W}$  (typical sensor module  $R_{\text{TH}}$ ) = 17 K.



**Figure 2** Recurring air-gap variation



**Figure 3** Non-recurring air-gap change

## 4 Functional Parameters

### 4 Functional Parameters

The magnetic input is assumed sinusoidal with constant amplitude and offset. The typical values shown below are valid for  $V_{DD} = 12\text{ V}$  and  $T_A = 25^\circ\text{C}$ .

**Table 6 Functional Parameters**

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Periodic jitter <sup>1)</sup>	$S_{jit}$	-	-	$\pm 0.07$	%	$\pm 1\sigma$ value; differential magnetic input signal and calibrated mode, frequency $1\text{ Hz} < f_{mag} < 3\text{ kHz}$ , amplitude $376\text{ }\mu\text{T} \leq \Delta B_X \leq 500\text{ }\mu\text{T}$ ; <a href="#">Figure 11</a> , <a href="#">Figure 12</a> , <a href="#">Figure 13</a>
Periodic jitter <sup>1)</sup>	$S_{jit}$	-	-	$\pm 0.05$	%	$\pm 1\sigma$ value; differential magnetic input signal and calibrated mode, frequency $1\text{ Hz} < f_{mag} < 3\text{ kHz}$ , amplitude $501\text{ }\mu\text{T} \leq \Delta B_X \leq 6.3\text{ mT}$ ; <a href="#">Figure 11</a> , <a href="#">Figure 12</a> , <a href="#">Figure 13</a>
Periodic jitter <sup>1)</sup>	$S_{jit}$	-	$\pm 0.02$		%	$\pm 1\sigma$ value; differential magnetic input signal and calibrated mode, frequency $1\text{ Hz} < f_{mag} < 3\text{ kHz}$ , amplitude $6.3\text{ mT} \leq \Delta B_X \leq 50\text{ mT}$ ; <a href="#">Figure 11</a> , <a href="#">Figure 12</a> , <a href="#">Figure 13</a>
Duty cycle	DC	40	-	60	%	In calibrated mode; sinusoidal input signal and calibrated mode; $f_{mag} > 1\text{ Hz}$ ; $s; DC = 100\% \cdot t_1/T$ , $B_{ext\_XYZ} = 0\text{ mT}$ , differential magnetic input signal amplitude $2x\text{ }dB_{limit\_x} \leq \Delta B_X \leq 50\text{ mT}$ ; <a href="#">Figure 14</a>
Power-on time <sup>1)</sup>	$t_{on}$	-	-	200	$\mu\text{s}$	
Magnetic edges required for first offset correction <sup>1)</sup>	$n_{start}$	-	-	4	-	$f_{mag} \geq 1\text{ Hz}$
Magnetic edges required for first output pulse <sup>1)</sup>	$n_{first\_pulse}$	1	-	2	-	After $t_{on}$
Supply current during static output low state PWM2/Protocol	$I_{low}$	5.95	7	8.05	mA	
Supply current during static output high state PWM2/Protocol	$I_{high}$	11.9	14	16.1	mA	
$I_{Error}$ failure indicating current	$I_{Error}$	1	3.5	3.8	mA	Low current indicates detected error
Output current slew rate	$SR_r, SR_f$	11	-	28	mA/ $\mu\text{s}$	See ; $SR_r = (I_{90\%} - I_{10\%}) / t_r$ ; $SR_f = (I_{90\%} - I_{10\%}) / t_f$

(table continues...)

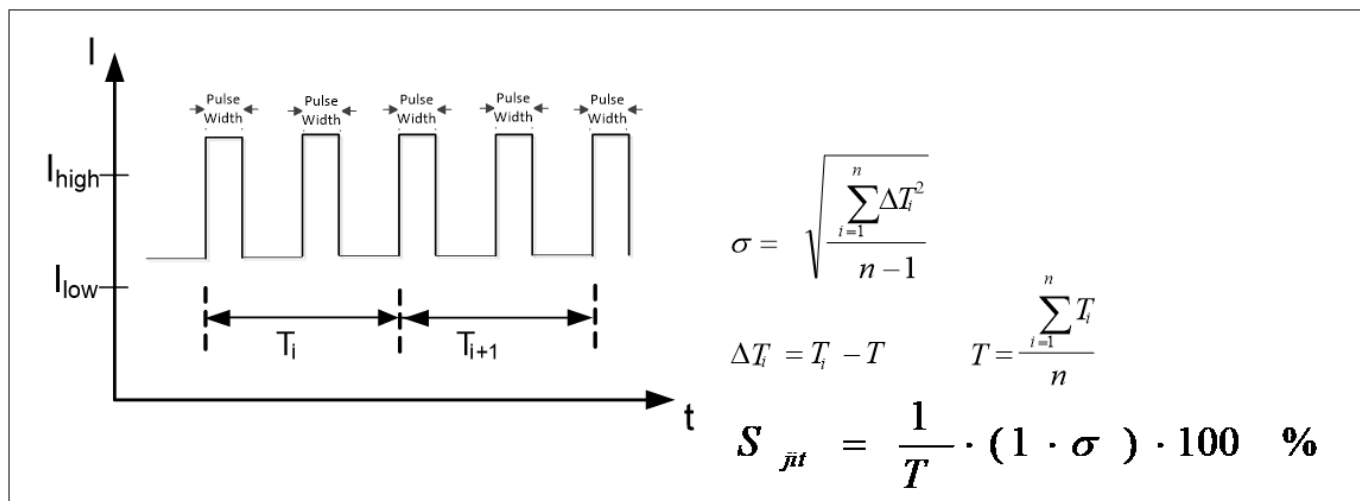


## 4 Functional Parameters

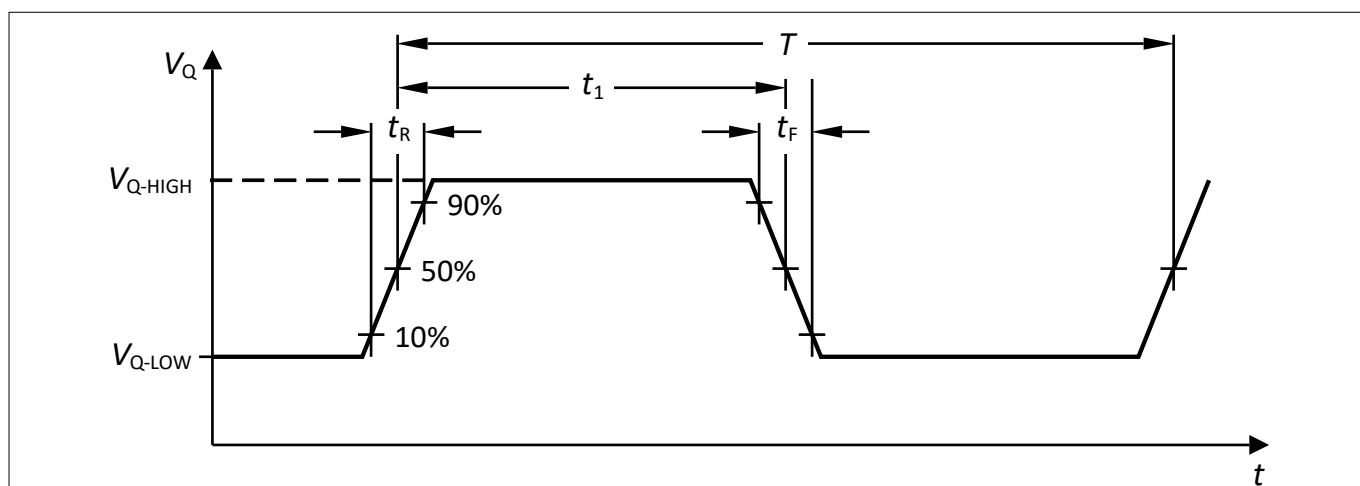
**Table 6** (continued) Functional Parameters

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Supply current ratio	$I_{\text{high}} / I_{\text{low}}$	1.9		2.2	-	Same temperature and same $R_m$ for both current levels
Switch-off voltage	$V_{\text{reset}}$			3.5	V	Direct on sensor pins <a href="#">Chapter 5.2.2</a>
Supply voltage hysteresis TLE5046SiC-PWM2/R100	$V_{\text{Hys}}$	1.5		1.7	V	<a href="#">Chapter 5.2.2</a>
Supply voltage hysteresis TLE5046SiC-PWM2/R050	$V_{\text{Hys}}$	0.65		0.75	V	<a href="#">Chapter 5.2.2</a>

1) Not subject to production test, verified by design/characterization.



**Figure 4** Period jitter definition for coil measurements



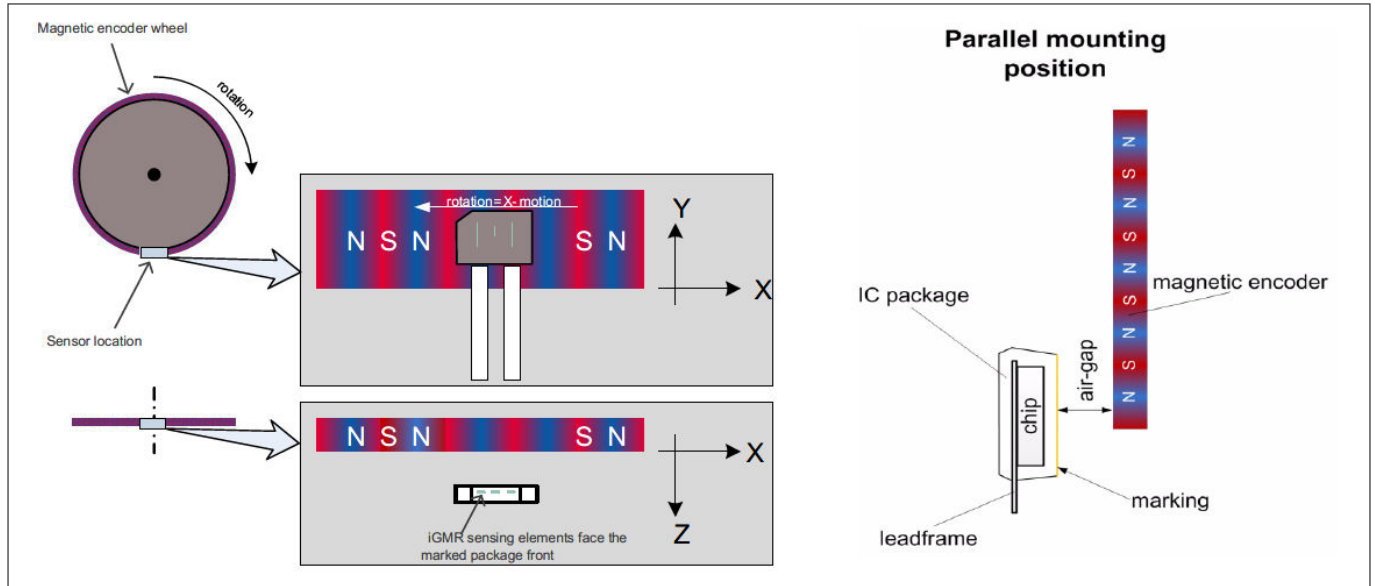
**Figure 5** Definition of Slew Rate and Duty Cycle =  $t_1/T \cdot 100\%$

## 5 Functional Description

### 5 Functional Description

The sensor element has a magnetic interface to detect the increments of a magnetized encoder and its direction: the sensing principle is based on the giant magneto resistance (GMR) principle sensitive to magnetic filed in x-direction. It is designed for maximum sensitivity and suppression of homogeneous fields.

In Figure 6, the typical placement of the TLE5046SiC-PWM2 facing a magnetic encoder wheel is shown.



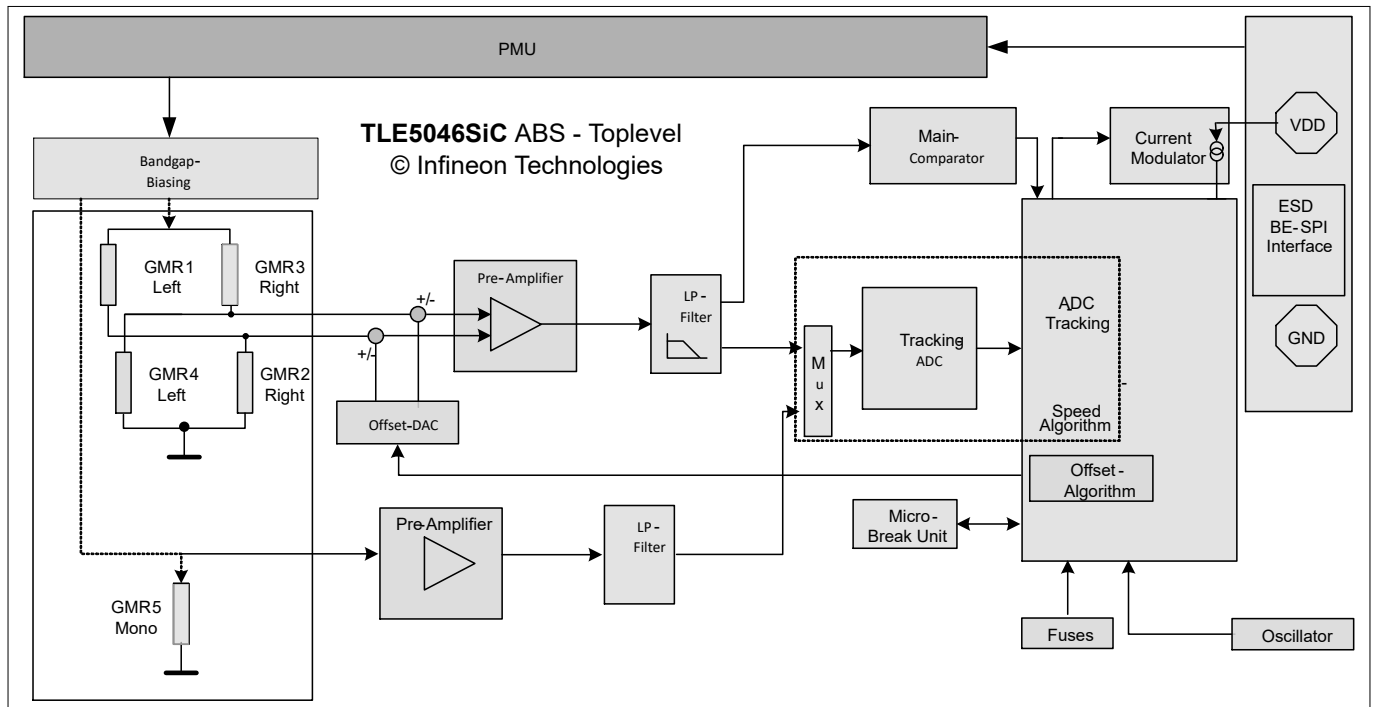
**Figure 6** TLE5046SiC in Magnetic Encoder Mounting Position

**Note:**  $Y = 0 \text{ mm}$  refers to the  $B_y = 0 \text{ mT}$  line of the magnetized stripe.

## 5 Functional Description

### 5.1 Block diagram

The sensing elements are integrated on the chip in a Wheatstone Bridge. The bridge is sensing a differential speed signal and suppressing external homogeneous fields. Each half bridge consists of two GMR elements 1.63 mm apart. The direction element is placed almost in the middle of the two speed elements. The signal path comprises a differential amplifier and a noise limiting low pass filter and a comparator. An offset cancellation loop is in place to compensate magnetic and electric offsets. The regulation loop consists of a tracking A/D converter, the digital core to evaluate the offset and the offset DAC to feed in the corrective voltage.



**Figure 7** Block diagram

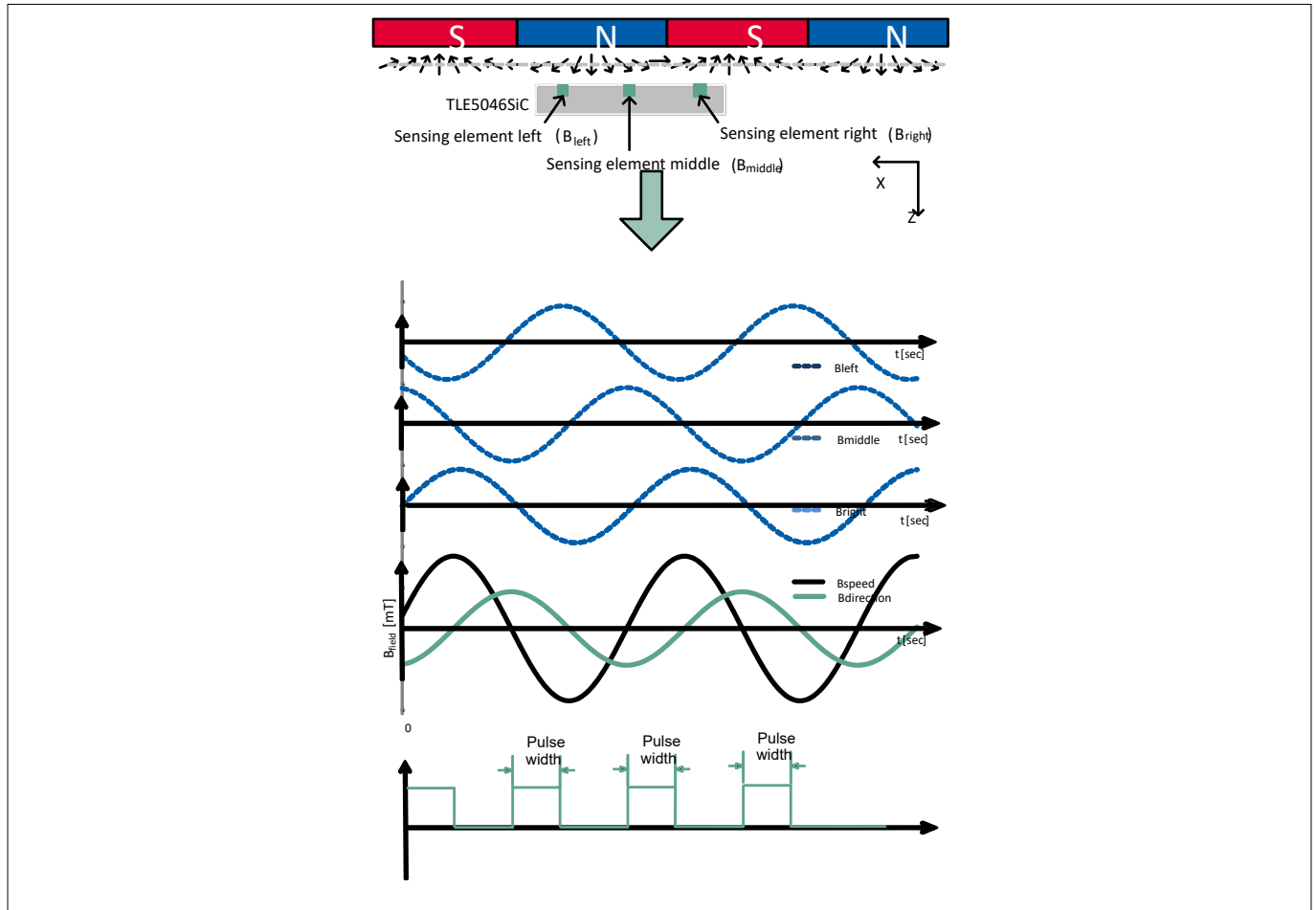
## 5 Functional Description

### 5.2 Switching Behavior

The first output pulse is generated when the input field exceeds the minimal magnetic threshold “ $2 \times dB_{limit}$ ”. This leads to phase shift in the Duty Cycle during uncalibrated mode (see Figure 9), but ensures the first pulse occurs on first pole pair, so the speed information is immediately available.

After minimum and maximum are detected and offset is compensated, output switching occurs at zero-crossing of the differential magnetic signal.

Direction information on the first output pulse in uncalibrated mode is unknown, this is indicated with the warning pulse but ensures that after startup, while direction is still invalid, a valid speed signal is issued.



**Figure 8** Magnetic input signal and corresponding output switching

## 5 Functional Description

### 5.2.1 Operating Modes

The device can be in one of two operating modes, namely uncalibrated mode or calibrated mode.

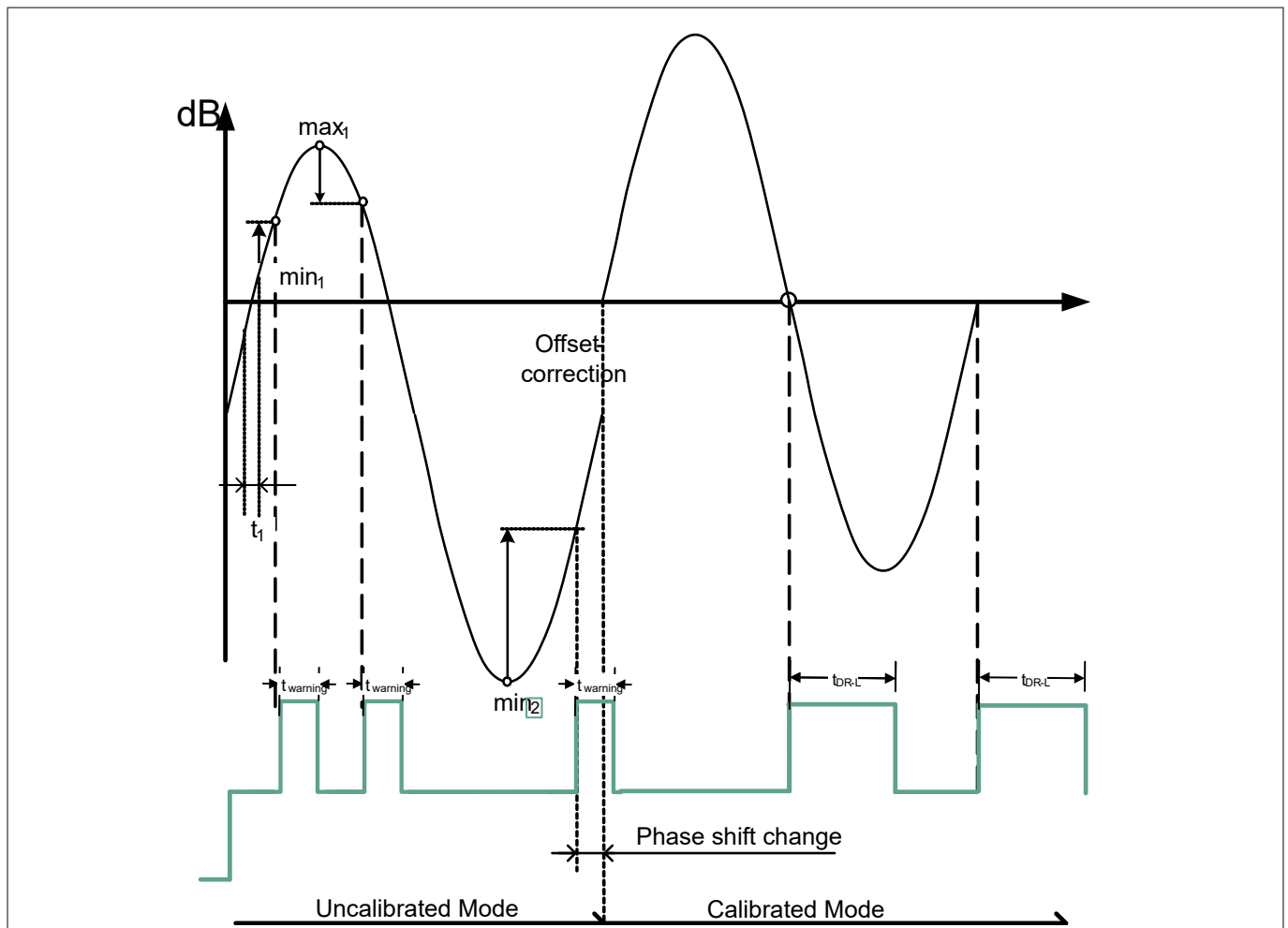
#### 5.2.1.1 Uncalibrated Mode

After supplying the device it starts tracking the input signal after power on time  $t_{on}$ . The device is now in uncalibrated mode with an initial fast offset compensation. In order to trigger the first edge, the magnetic input signal has to exceed  $2 \cdot dB_{limit\_x}$ .

The device switches over to calibrated mode when proper offset compensation is achieved. After the calibration is finished the device operates with its full performance.

##### 5.2.1.1.1 Calibrated Mode

In calibrated mode the output will switch at zero-crossing of the input signal. Signals below a defined threshold  $dB_{limit\_x}$  do not trigger the current interface to avoid noise induced unwanted output switching. The calibrated mode provides a slower offset compensation to achieve the best jitter performance.



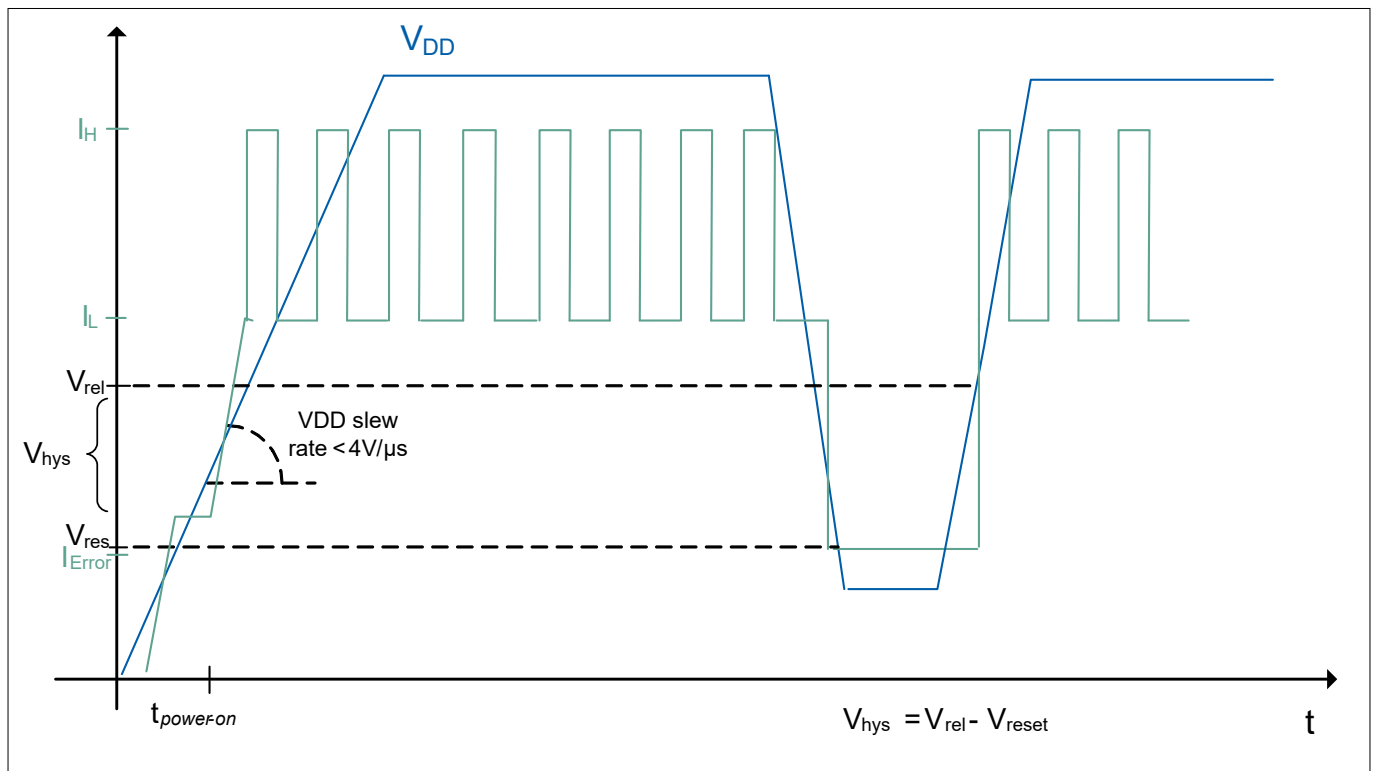
**Figure 9** First positive offset correction

## 5 Functional Description

### 5.2.2 Undervoltage Behavior

A hysteresis  $V_{hys}$  is implemented depending on the resistor in use avoiding a toggling of the output when the supply voltage  $V_{DD}$  is modulated due to the additional voltage drop at  $R_M$  when switching from low to high current level.

If the supply voltage  $V_{DD}$  drops below the switch-off level  $V_{reset}$  the sensor reduces its current consumption to  $I_{Error}$  regardless of the magnetic encoder input signal. After  $V_{DD}$  exceeding again the voltage release level  $V_{release}$  the sensor restarts and resumes in normal operation. The minimum required supply voltage  $V_{DD}$  for the chip to power on is defined by the voltage release level  $V_{rel}$ . During  $t_{power-on}$ , the current  $I$  will not exceed the level for  $I_{low}$ .



**Figure 10** Undervoltage behavior

### 5.2.3 Watchdog

An innovative temperature watchdog has been designed to maximize the sensor availability and avoid wrong sensor output in extreme conditions created by temperature drift in absence of motion.

### 5.2.4 Safety Mechanisms

The TLE5046SiC offers safety features to support the Automotive Safety Integrity Level ASIL B and is designed to be used in ASIL D systems.

An embedded safety concept was developed to minimize the effect of hard and soft random errors by the introduction of specific safety mechanisms. In case of an internal error a notification to the ECU is transmitted by either setting the output current level to a constant failure indication level  $I_{Error}$  or transmitting an error flag via the protocol.

PWM2 version is designed to have a longer standstill period compared to the standard PWM version and in case a SM is active and standstill condition is present, the warning will not be broadcasted. This means the warning information is NOT dominant towards the standstill pulse. As long as the standstill condition is given; standstill pulses will be transmitted. With the next zero crossing speed event the warning pulse will indicate that a SM is active; this condition will last as long as the failure is persistent. For details please see the respective Safety Manual.

## 5 Functional Description

Following safety mechanisms have been implemented including:

- Undervoltage detection
  - This safety mechanism detects voltage drops to values where the correct functionality of the circuitry is no more ensured. The sensor remains in this state until the error condition is solved and  $V_{DD}$  is back into normal operating range
- Detection of discrepancy between number of active fuses and internally stored number of fuses
  - This safety mechanism compares the active fuse bits against the internal stored quantity. The sensor remains in this failure indication state  $I_{Error}$  until the device is powered off and on again and the error condition is not present any longer
- Detection of clock malfunction
  - This safety mechanism forces the failure indication state if the clock is either stuck or below 25% of the nominal value
- Detection of different numbers between speed and direction path
  - This safety mechanism verifies if more than two consecutive electric events are generated without any detected event in the direction path or vice versa
- Detection of critical airgap, ADC clipping and temperature monitoring
  - This safety mechanisms verifies critical states inside the ASIC itself

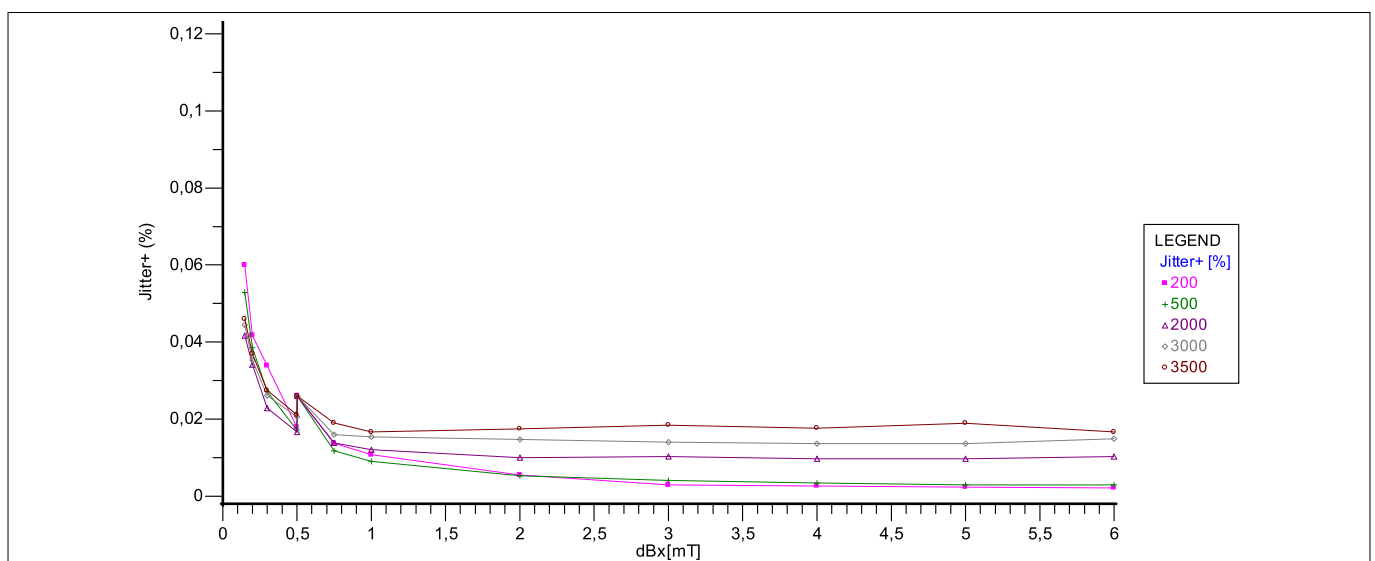
The full overview including detailed descriptions of the functionality of each safety mechanism and the detailed failure reaction can be found in the safety manual.

All Infineon experience has been used to identify and prevent common cause of failure in the application including EMC disturbances and mechanical tolerances. An advanced EMC concept, inclusive of microbreak feature without the need of external components, maximizes the availability of the sensor signal at the electrical interface. And the speed algorithm is designed for fast start-up and optimization of duty cycle. The extreme low jitter of the sensor contributes to high time accuracy of the speed signal.

TLE5046SiC is accompanied by accurate safety analysis and complete documentation to enable the system integrator to quickly evaluate the compatibility with the system/item and start the integration process. A detailed description of how the sensor is to be used in an ISO26262 compliant system can be found in the Safety Manual and Safety Analysis Summary Report, which are available on request.

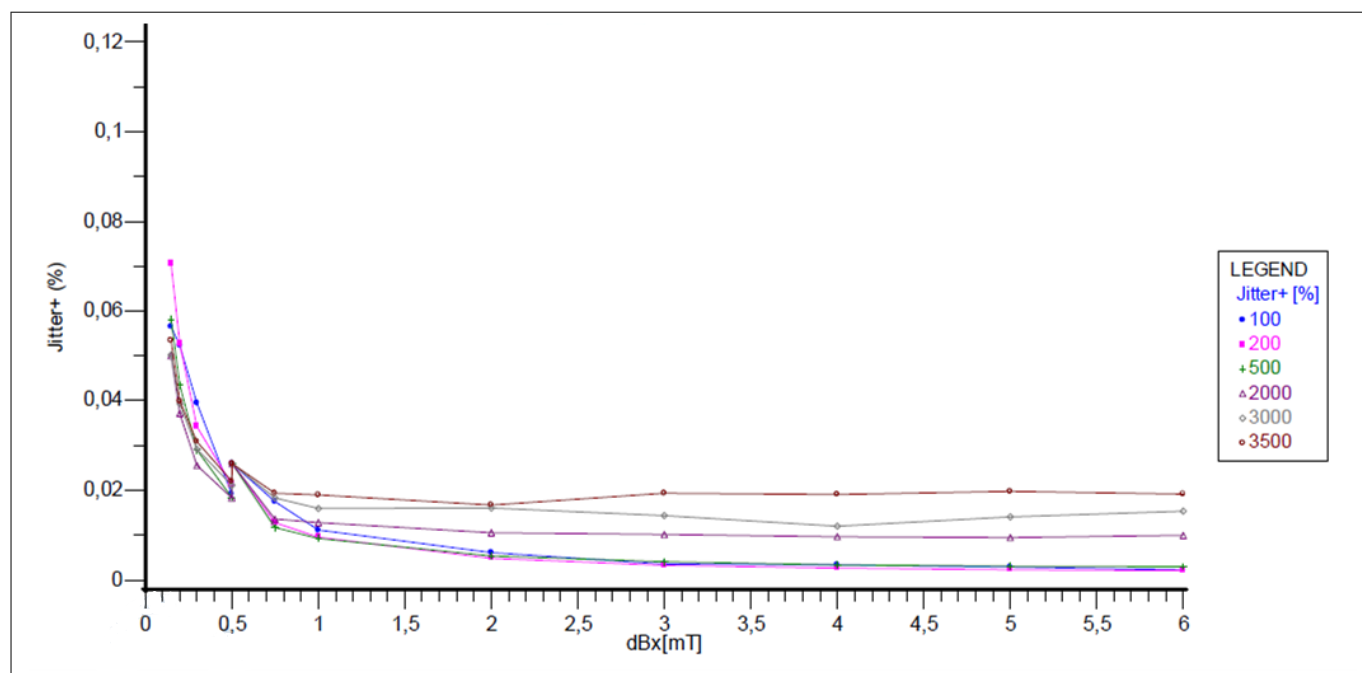
### 5.3 Typical Performance

Based on characterization results the following typical data was evaluated. The extreme low jitter of the sensor contributes to high time accuracy of the speed signal. In general a very low jitter floor can be seen over the full frequency and temperature range at small fields as well as larger fields.

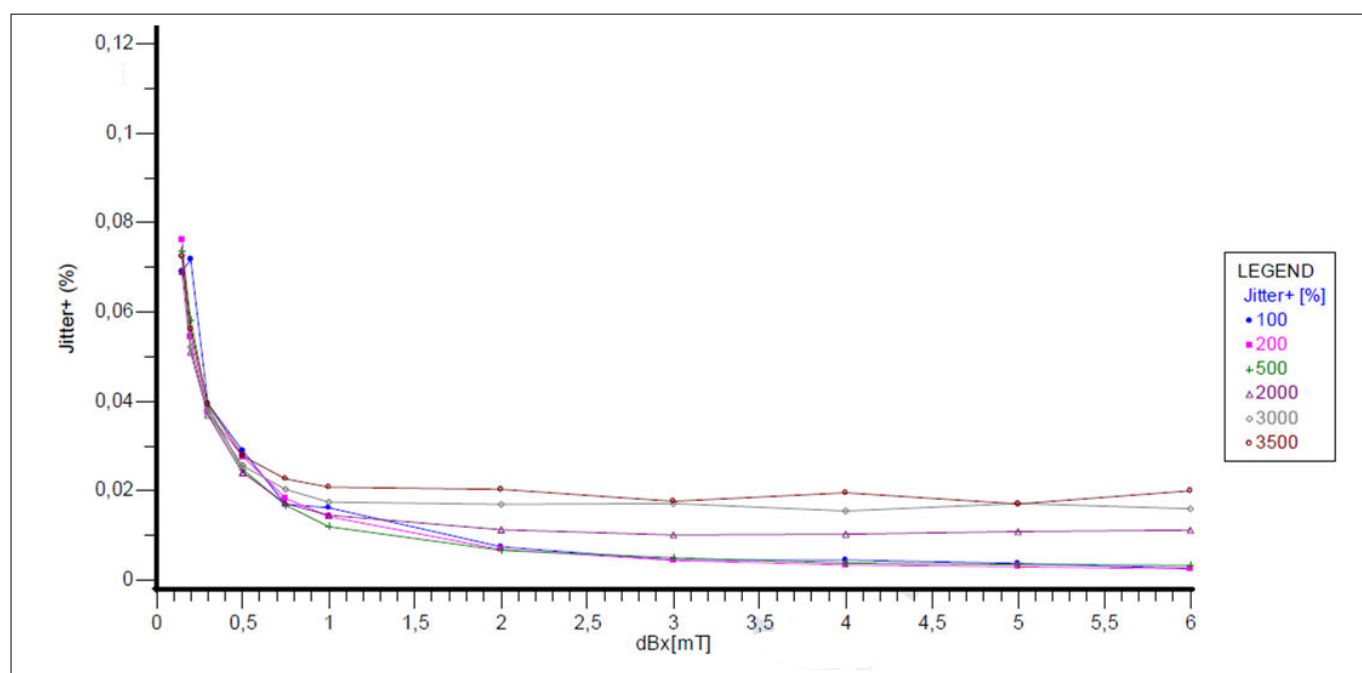


**Figure 11** Jitter performance over different frequencies  $T_a = -40^\circ\text{C}$

## 5 Functional Description



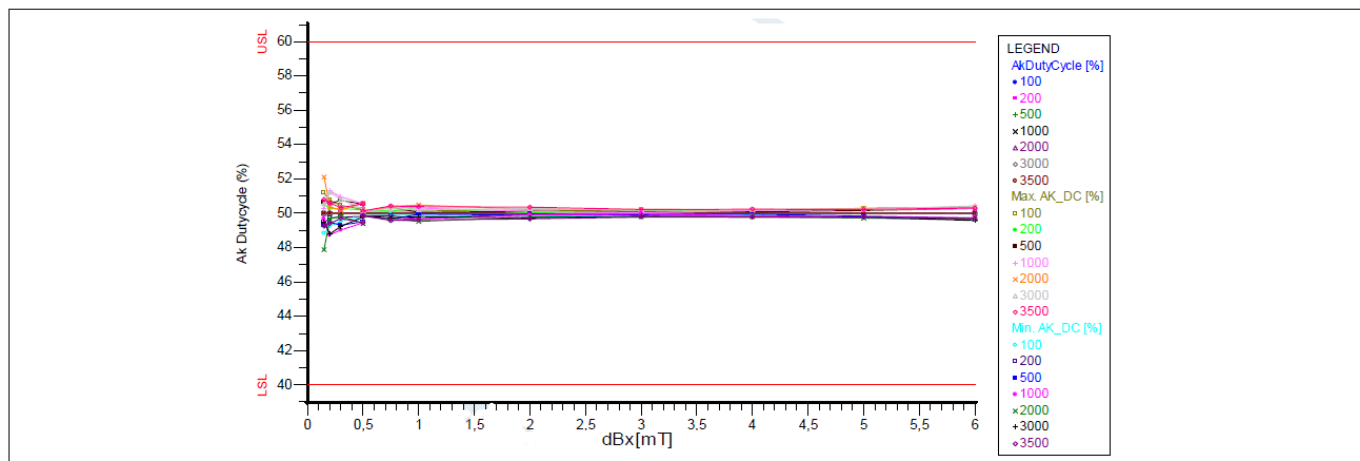
**Figure 12** Jitter performance over different frequencies Ta = 25°C



**Figure 13** Jitter performance over frequency Ta = 175°C

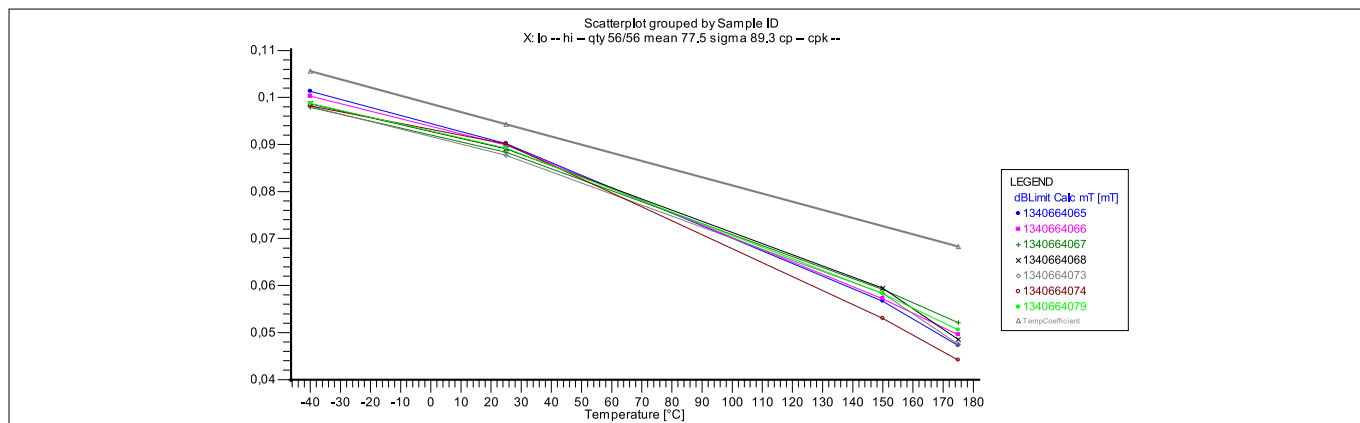


## 5 Functional Description



**Figure 14** Duty Cycle performance

The sensor is designed with a temperature coefficient of -2000 ppm/K to compensate the temperature dependency of magnetic materials. This ensures, that with varying temperature the air gap stays constant.

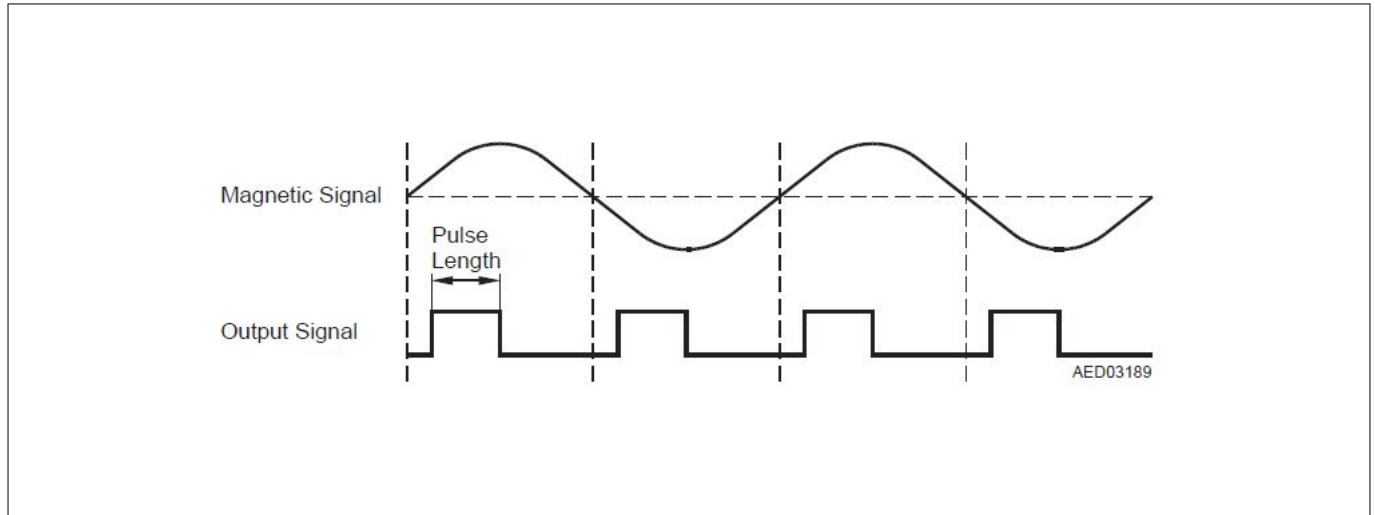


**Figure 15** dBlimit over temperature with implemented Temperature coefficient of -2000 ppm/K

## 6 PWM2/Protocol Description

### 6 PWM2/Protocol Description

The output has been designed as a two wire current interface based on a Pulse Width Modulation principle. Each zero crossing of the magnetic input signal triggers an output pulse indicated by IHigh and ILow current consumption.



**Figure 16** Zero-Crossing Principle and Corresponding Output Pulses

#### 6.1 Timing Characteristics

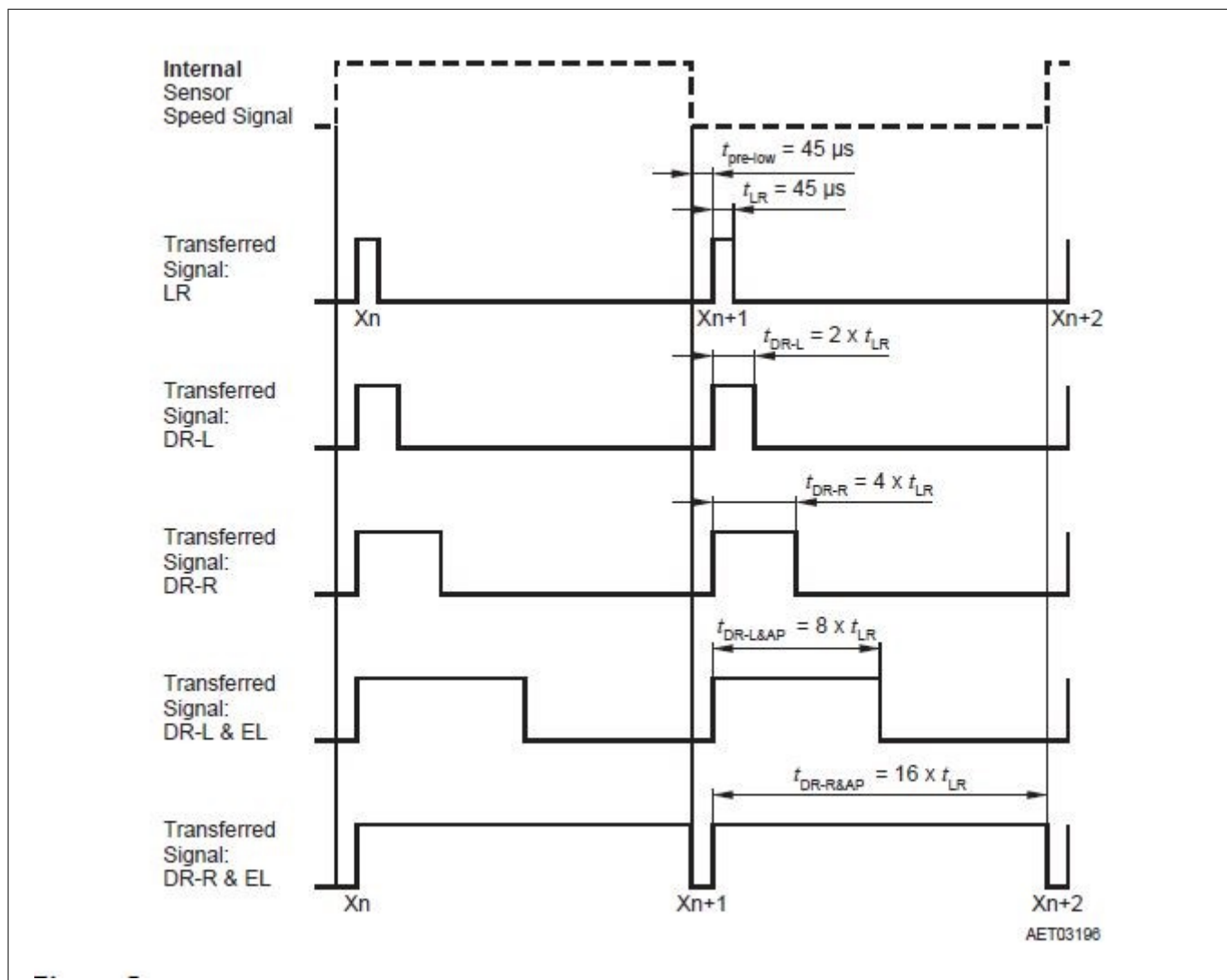
**Table 7** Timing Characteristics TLE5046SiC-PWM2

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
Pre-low length	t <sub>pre-low</sub>	38	45	52	μs	
Length of Warning pulse	t <sub>Warning</sub>	38	45	52	μs	
Length of DR-L pulse	t <sub>DR-L</sub>	76	90	104	μs	
Length of DR-R pulse	t <sub>DR-R</sub>	153	180	207	μs	
Length of DR-L & EL pulse	t <sub>DR-L&amp;EL</sub>	306	360	414	μs	
Length of DR-R & EL pulse	t <sub>DR-R&amp;EL</sub>	616	720	828	μs	
Output of EL pulse, maximum frequency	f <sub>ELmax</sub>	–	117	–	Hz	
Length of stand still pulse	t <sub>Stop</sub>	1.232	1.4	1.656	ms	
Stand still period	T <sub>Stop</sub>	590	737	848	ms	
ΔB <sub>EL</sub>	ΔB <sub>EL</sub>		345		μT	4*ΔB <sub>limit</sub>
ΔB <sub>Warning</sub>	ΔB <sub>Warning</sub>		160		μT	2*ΔB <sub>limit</sub>

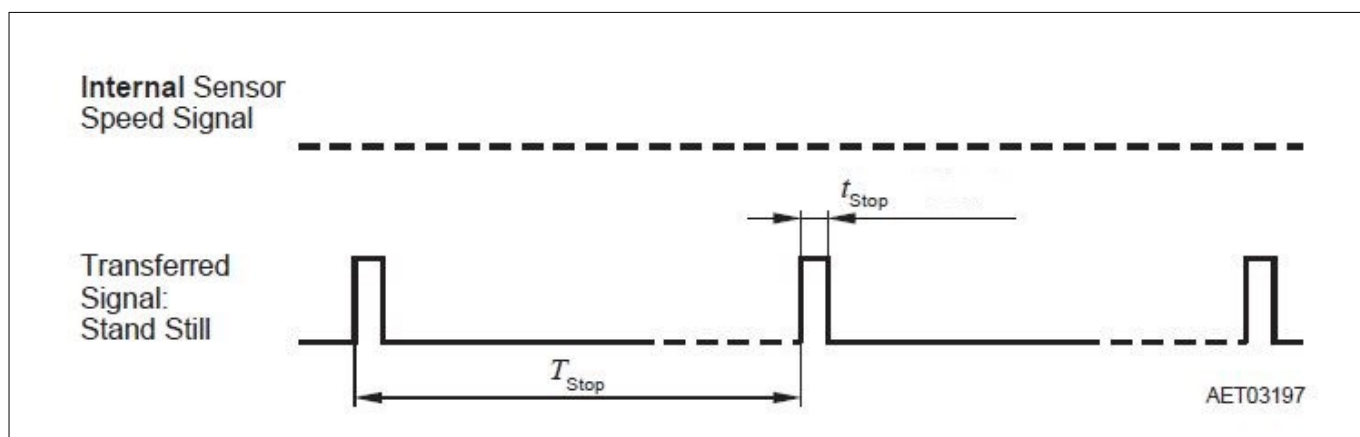
Due to decreasing cycle times at higher frequencies, the longer pulses (EL) are only output up to frequencies of approximately 117 Hz. For higher frequencies and differential magnetic fields below ΔB<sub>EL</sub>, the output pulse lengths are 90 μs or 180 μs respectively. If the magnitude of the magnetic differential field is below ΔB<sub>Warning</sub>, the output pulse length is 45 μs. The warning pulse length is also used for indicating an incorrect direction. The warning output is dominant, this means that close to the limit Airgap the direction and the assembly position information are disabled. For magnitudes of the magnetic differential field below ΔB<sub>limit</sub>, signal is lost. In case no magnetic differential signal is detected for a time longer than the stand still period T<sub>Stop</sub>, the stop pulse is

## 6 PWM2/Protocol Description

output. Between each magnetic transition and the rising edge of the corresponding output pulse the output current is low for  $t_{\text{pre-low}}$ .



**Figure 17** Definition of PWM2/Interface



**Figure 18** Definition of PWM Interface Standstill

## 6 PWM2/Protocol Description

### Direction of rotation right and left pulse

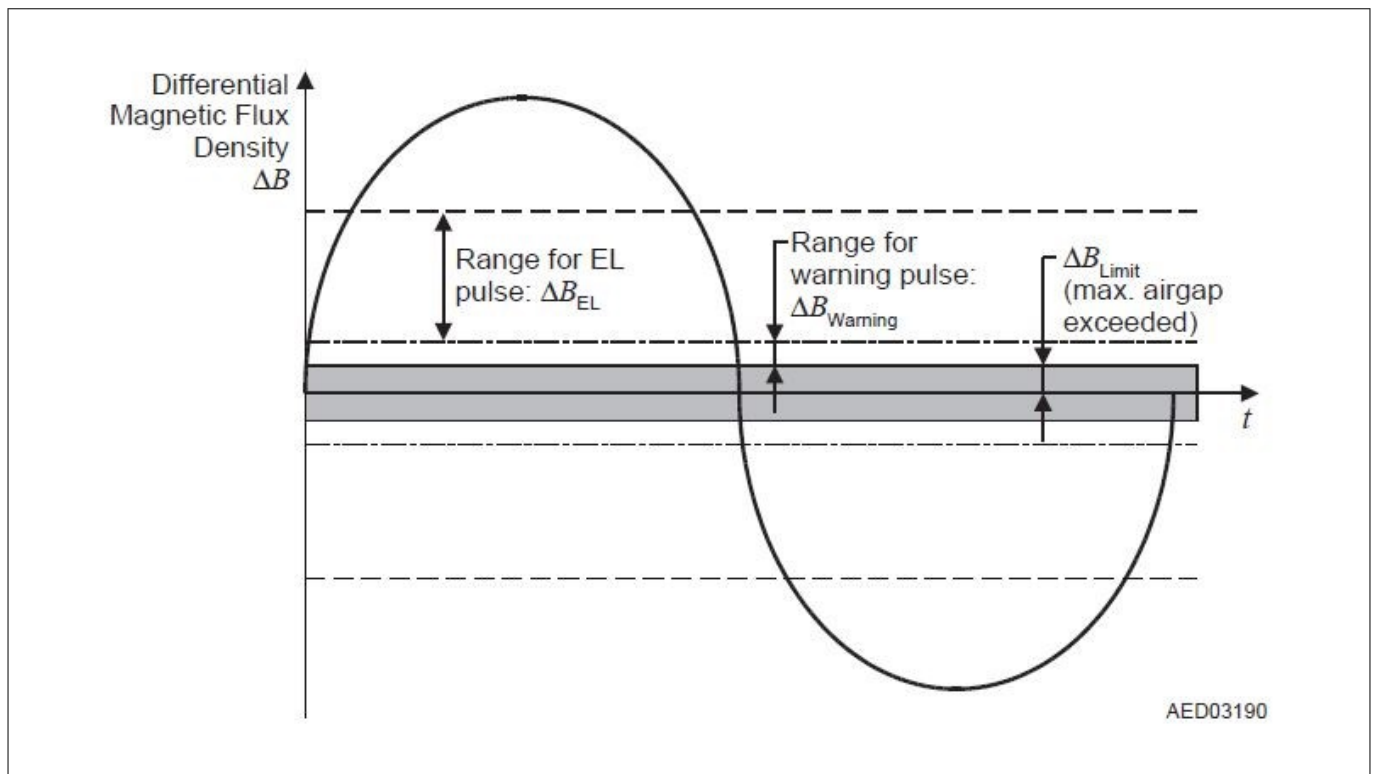
DR-R information is issued in the output pulse length when the target wheel in front of the IC moves from the pin GND to the pin VCC see [Figure 1](#). DR-L information is issued in the output pulse length when the target wheel in front of the IC moves from the pin VCC to the pin GND.

### EL pulse range

If the magnetic differential field exceeds  $\Delta B_{EL}$  (Einbaulage), the output pulse lengths are  $90\ \mu\text{s}$  or  $180\ \mu\text{s}$  respectively, depending on the direction of rotation. When the magnitude of the magnetic differential field is below  $\Delta B_{EL}$ , the output pulse lengths are  $360\ \mu\text{s}$  and  $720\ \mu\text{s}$  respectively, depending on left or right rotation. The device works with full functionality.

### Warning pulse range

Warning pulse information is issued in the output pulse length when the magnetic field is below a critical value (for example, the air-gap between the IC and the target wheel exceeds a critical value).



**Figure 19** Definition of Differential Magnetic Flux Density Ranges

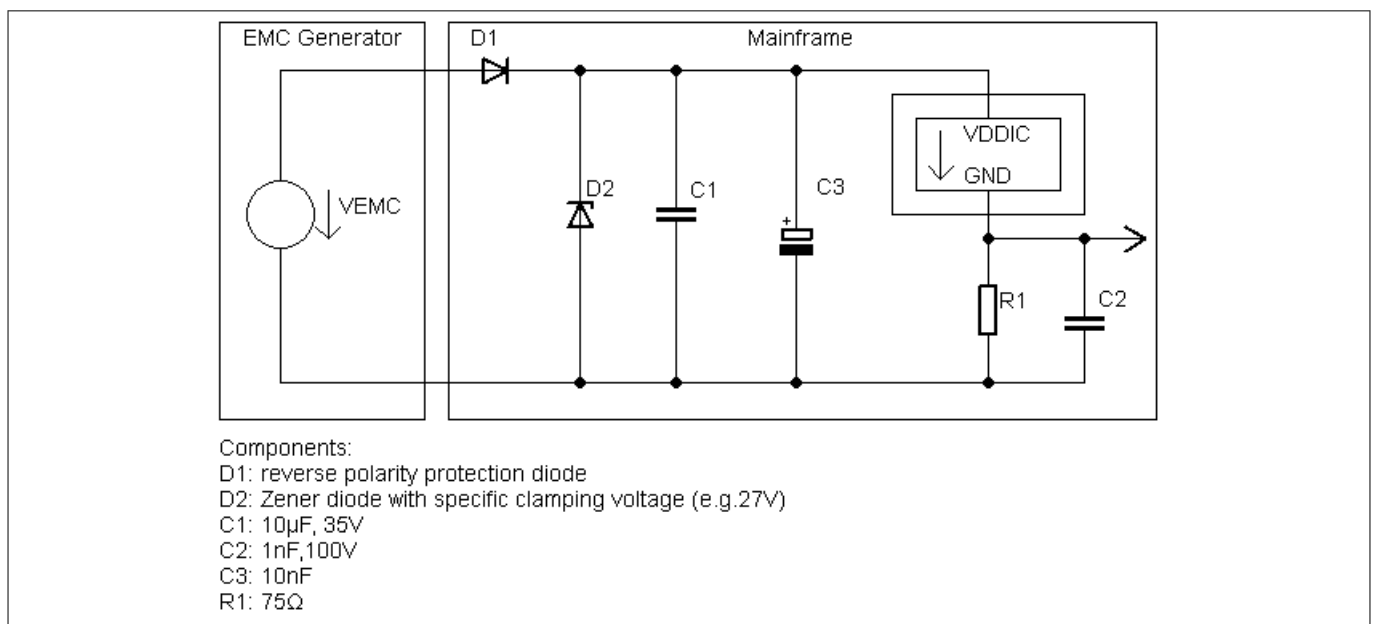
## 7 EMC and ESD Characteristics

The TLE5046SiC is characterized according to the IC level EMC requirements described in the “Generic IC EMC Test Specification” Version 2.0 from 2014. EMC test report is available on request.

Additionally component level EMC characterizations are performed according to ISO 7637-2:2011, ISO 7637-3:2007 and ISO 16750-2:2010 regarding pulse immunity and CISPR 25 (2009-01) Ed. 3.0 regarding conducted emissions are performed.

Characterization of Electro Magnetic Compatibility are carried out on a sample base of one qualification lot. Not all specification parameters have been monitored during EMC exposure. Only current levels and duty cycle have been monitored.

### 7.1 Transient Immunity



**Figure 20**      **EMC Test circuit**

## 7 EMC and ESD Characteristics

### 7.1.1 Electrical Transient Conduction along Supply Lines

General requirements:

- The supply voltage has a value of  $13.5 \text{ V} \pm 0.2 \text{ V}$  (for test pulse 4 supply voltage is  $12 \text{ V} \pm 0.2 \text{ V}$ )
- The ambient temperature for these tests is  $23^\circ\text{C} \pm 5^\circ\text{C}$

Test setup:

- According to ISO 7637-2, 2011 chapter 4.4 for pulses 1, 2a, 2b, 3a and 3b
- According to ISO 16750-2, 2010 chapter 4.6.3 and 4.6.4 for pulses 4 and 5b
- The Loadbox is placed directly on the ground plane
- The wiring harness and the monitoring equipment are insulated 50 mm from the ground plane
- Total wire harness length from the test pulse generator to the DUT does not exceed 500 mm and does not fall below 400 mm including a harness length from the load simulator to the DUT of  $200 \text{ mm} \pm 50 \text{ mm}$
- Pulses are applied to the input terminal of the Loadbox

**Table 8 Applicable Pulses, Parameters and Functional Class Requirements**

Test Pulses	Test Level	Number/Duration	Pulse parameters	Functional class
1	-150 V	500	$t_d = 2 \text{ ms}$ , $t_1 = 0.5 \text{ s}$	C
2a	+112 V	5000	$t_d = 50 \mu\text{s}$ , $t_1 = 0.5 \text{ s}$ , $R_i = 2 \Omega$	A
2b	+10 V	10	$t_d = 1$ , $R_i = 0.01 \Omega$	C
3a	-220 V	10 min	$t_d = 150 \text{ ns}$ , $R_i = 50 \Omega$	A <sup>1)</sup>
3b	+150 V	10 min	$t_d = 150 \text{ ns}$ , $R_i = 50 \Omega$	A <sup>1)</sup>
4 - I	$U_{S6} = 8 \text{ V} \mid U_S = 9.5 \text{ V}$	10	$t_8 = 1 \text{ s}$ , $t_r = 40 \text{ ms}$ , pulse cycle time: $2 \text{ s}$ <sup>2)</sup>	A
4 - II	$U_{S6} = 4.5 \text{ V} \mid U_S = 6.5 \text{ V}$	10	$t_8 = 10 \text{ s}$ , $t_r = 100 \text{ ms}$ , pulse cycle time: $2 \text{ s}$ <sup>3)</sup>	C
4 - III	$U_{S6} = 3 \text{ V} \mid U_S = 5 \text{ V}$	10	$t_8 = 1 \text{ s}$ , $t_r = 100 \text{ ms}$ , pulse cycle time: $2 \text{ s}$ <sup>3)</sup>	C
4 - IV	$U_{S6} = 6 \text{ V} \mid U_S = 6.5 \text{ V}$	10	$t_8 = 10 \text{ s}$ , $t_r = 100 \text{ ms}$ , pulse cycle time: $2 \text{ s}$ <sup>3)</sup>	C
5b	+35 V <sup>4)</sup>	1	$t_d = 400 \text{ ms}$ , $R_i = 1 \Omega$ , pulse cycle time: $60 \text{ s}$ <sup>3) 5)</sup>	C

1) Output signal overlaid by burst pulses.

2) Additional Pulse parameters:  $t_f = 5 \text{ ms}$ ,  $t_6 = 15 \text{ ms}$ ,  $t_7 = 50 \text{ ms}$ .

3) Non-specified pulse parameters according ISO16750-2, 2010.

4) Clamping voltage.

5) The 18 V Zener-Diode D2 in the load replacement circuit will be replaced by a special suppressor diode for this pulse to limit the pulse voltage to approximately 20 V and to prevent a damage of D2 during the test.

## 7 EMC and ESD Characteristics

### 7.1.2 Electrical Transient Transmission by Capacitive Coupling Clamp (CCC)

Conditions:

- The supply voltage has a value of  $13.5\text{ V} \pm 0.2\text{ V}$
- The ambient temperature for these tests is  $23^{\circ}\text{C} \pm 5^{\circ}\text{C}$

Test setup:

- According to ISO 7637-3, 2007 Chapter 3.4.2
- The monitoring equipment is insulated 50 mm from the ground plane
- Wire harness length is 1700 mm, wiring harness outside the Capacitive Coupling Clamp is 100 mm insulated
- All lines are tested simultaneously under the CCC

**Table 9 Test Level and Criteria for Fast Pulses Measurement**

Test Pulse	Test Level $U_s$	Internal resistance	Pulse parameters <sup>1)</sup> $t_1$   $t_d$	Minimum number of pulses or test time	Functional class
3a	-220 V	$R_i = 50\ \Omega$	100 $\mu\text{s}$   100 ns	10 min	A
3b	+150 V	$R_i = 50\ \Omega$	100 $\mu\text{s}$   100 ns	10 min	A

1) Non-specified pulse parameters according to ISO 7637-3, 2007

### 7.1.3 ESD HBM & CDM

**Table 10 ESD Voltage**

Parameter	Symbol	Values			Unit	Note or Test Condition
		Min.	Typ.	Max.		
ESD voltage	$V_{\text{HBM}}$	-	-	$\pm 12$	kV	Method AEC-Q100-002 (1.5 k $\Omega$ , 100 pF)
ESD voltage	$V_{\text{CDM}}$	-	-	$\pm 1$	kV	Method AEC-Q100-011 (0 k $\Omega$ , 200 pF)

## **8 Product Qualification**

Product qualification according to AEC-Q100, Grade 0 is performed.



## 9 Package Outlines

### 9.1 Bending and assembly

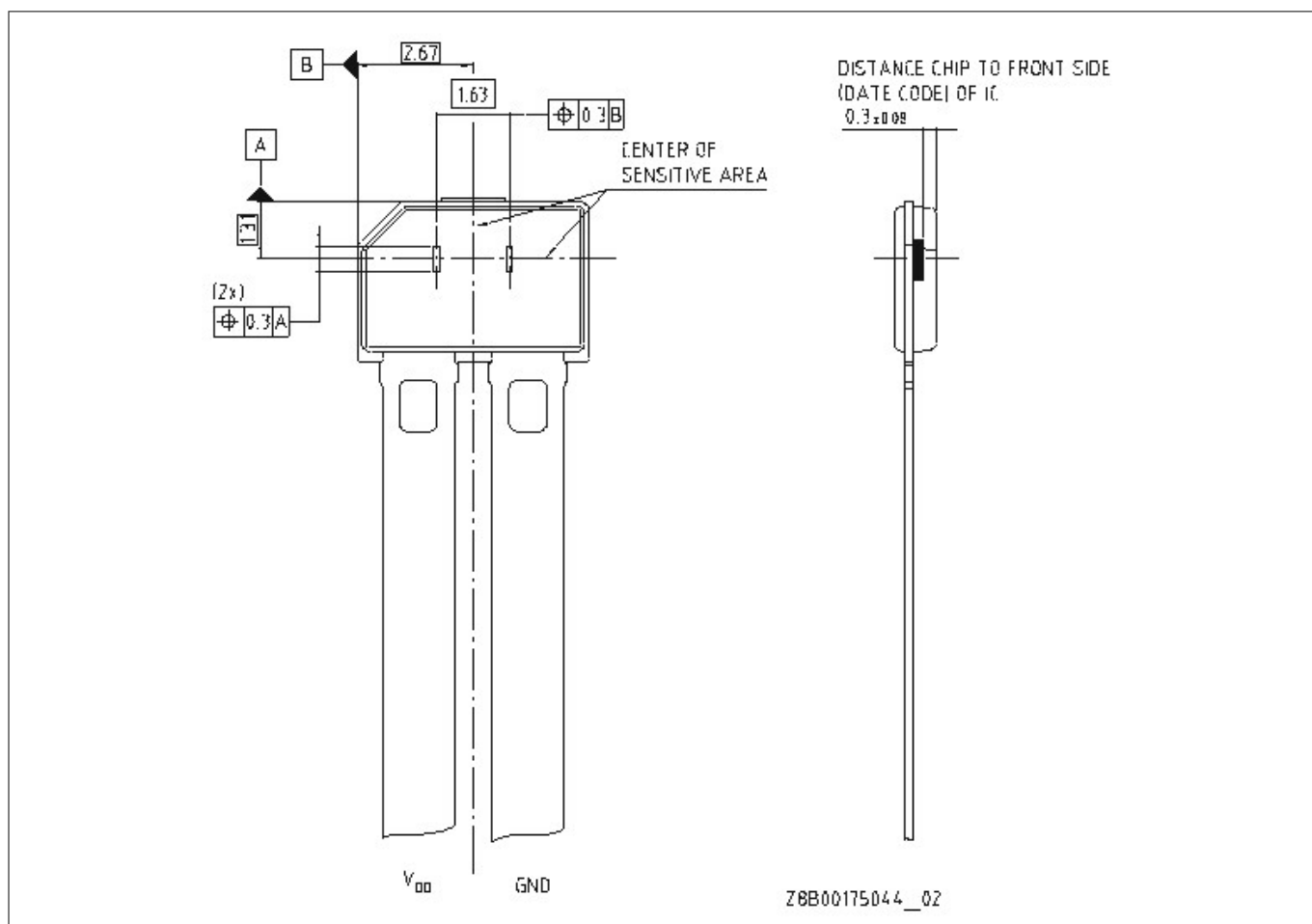
By following our package handling and assembly recommendation<sup>1)</sup> remarks for Sensor-packages the sensor terminals can be bent without causing incipient cracks influencing the sensor element function, please contact your key account team for further information. The product is RoHS (restriction of hazardous substances) compliant when marked with letter G in front or after the data code marking and contains a data matrix code. Please refer to your key account team or regional sales if you need further information.

**Table 11**      **Package Parameters PG-SSO-2-1**

Parameter		Material
Lead Frame	CuSn1CrNiTi	K62 (UNS:C18090)
Lead Plating	Sn	Tinn

### 9.2 Package surface to silicon

The distance from the package surface to the surface of the silicon chip.

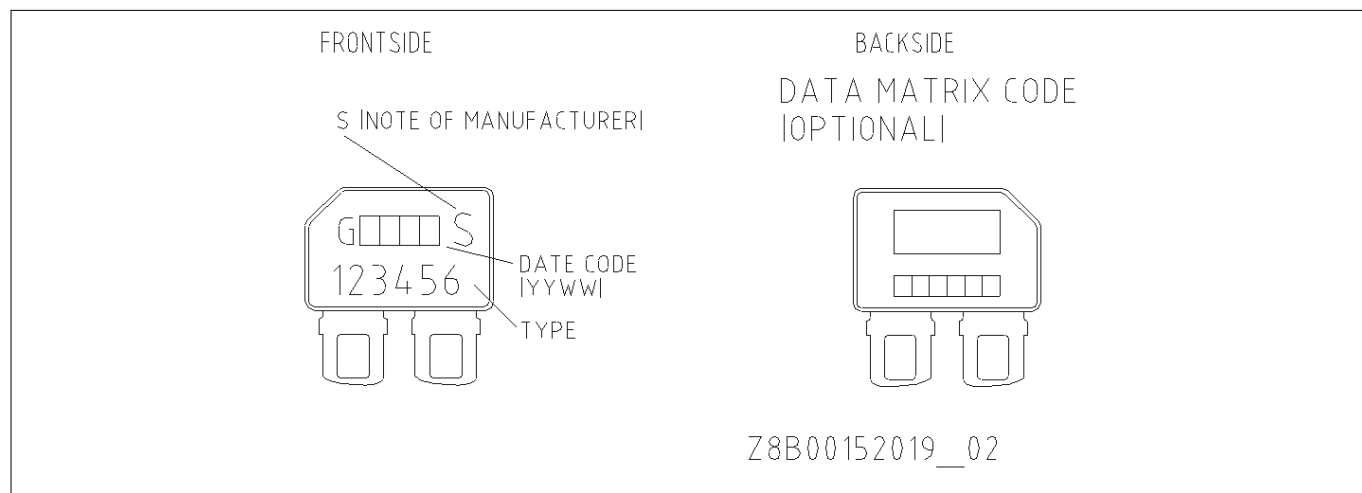


**Figure 21**      **Distance from package surface to silicon (= sensing element)**

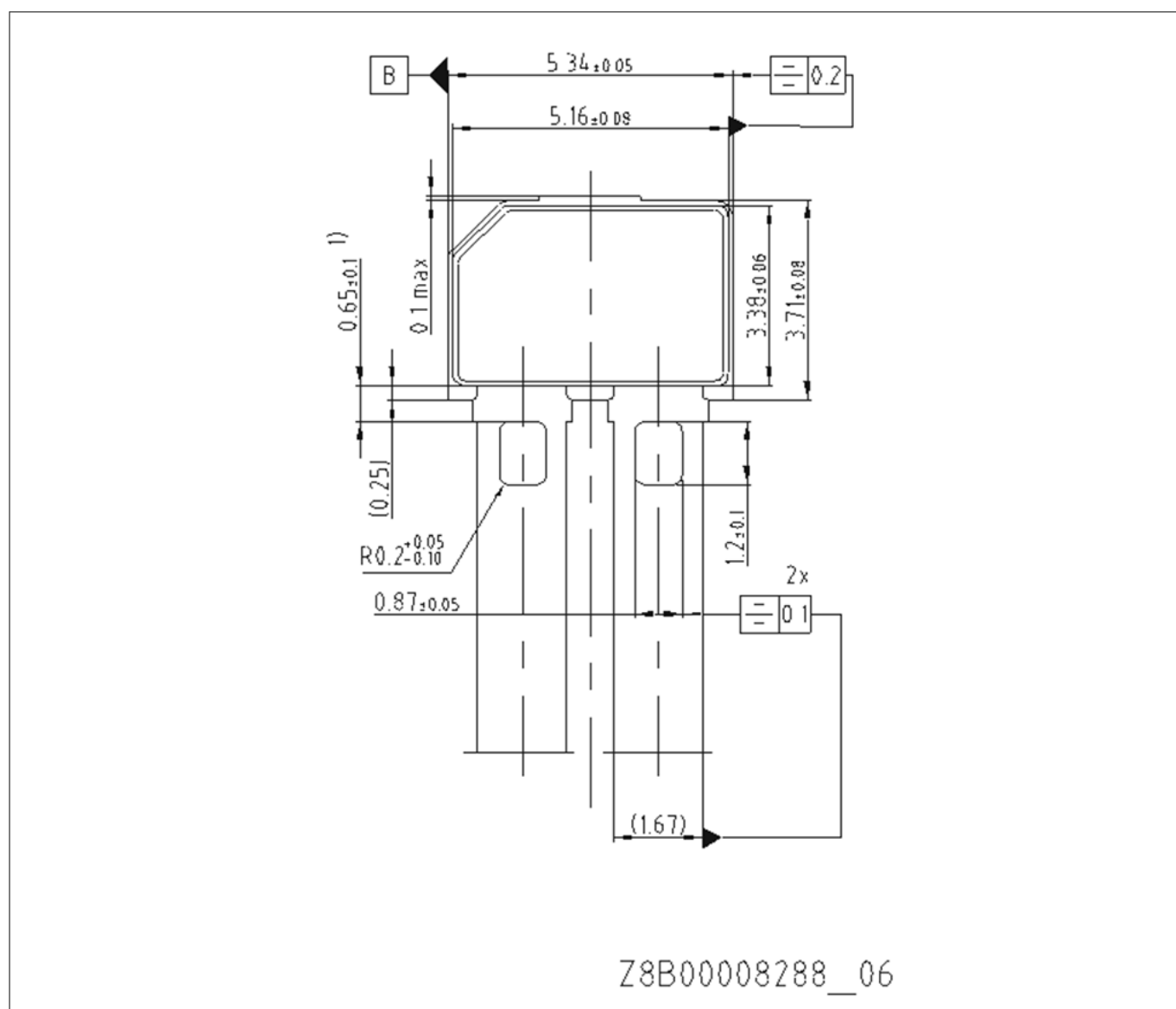
<sup>1</sup> The document is available at <https://www.infineon.com/dgdl/Infineon-Recommendation>.

## 9 Package Outlines

### 9.3 Package

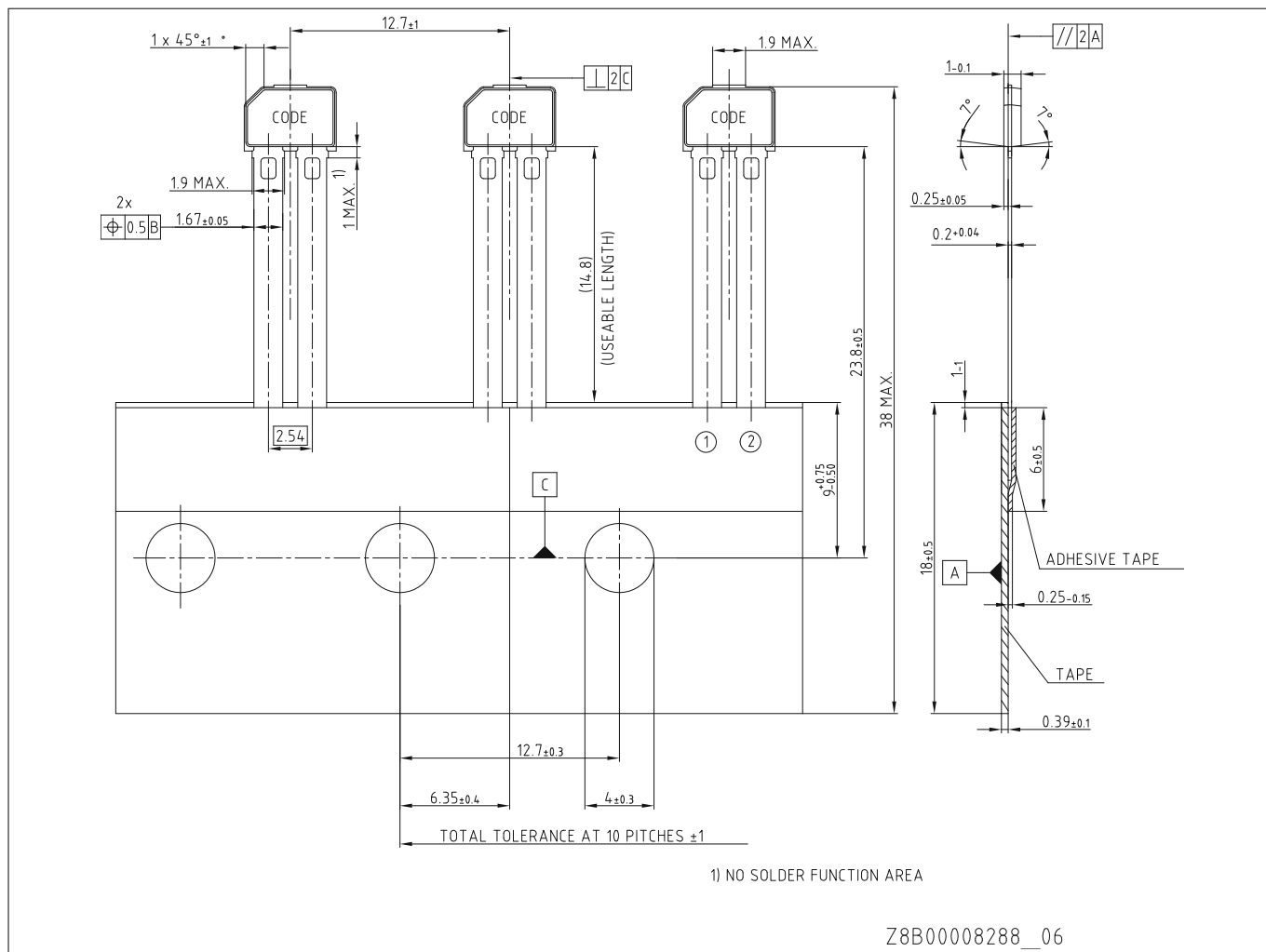


**Figure 22** PG-SSO-2-1 marking



**Figure 23** PG-SSO-2-1 package outline

**9 Package Outlines**



**Figure 24 PG-SSO-2-1 packing**

Dimensions in mm

**Note:** For further information on alternative packages, please visit our website: <https://www.infineon.com/cms/en/product/packages/?redirId=54632website>.

## 10 Terminology

### 10 Terminology

Reference	Description
ADC	Analog to Digital Converter
ASIC	Application Specific Integrated Circuit
CCC	Capacitive Coupling Clamp
CDM	Charged Device Model
DAC	Digital Analog Converter
DUT	Device Under Test
ECU	Electronic Control Unit
EMC	Electro Magnetic Compatibility
ESD	Electro Static Discharge
GMR	Giant Magneto Resistance
HBM	Human Body Model
IC	Integrated Circuit
PMU	Power Management Unit
RF	Radio Frequency

## References

- [1] *AEC-Q100*
- [2] *CISPR 25, 2009*
- [3] *IEC 61967-4, 2002*
- [4] *ISO 10605, 2008*
- [5] *ISO 11452-8, 2007*
- [6] *ISO 16750-2, 2010*
- [7] *ISO 26262, 2011*
- [8] *ISO 7637-2, 2011*
- [9] *ISO 7637-3, 2007*
- [10] *Safety Manual TLE5046SiC*
- [11] *Safety Analysis Summary Report TLE5046SiC*

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**Revision history**

**Revision history**

<b>Document version</b>	<b>Date of release</b>	<b>Description of changes</b>
1.0	2024-02-06	First release

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